

#### **Features**

Fast response time

High photo sensitivity

Small junction capacitance

Small junction capacitance

Pb free

The product itself will remain within RoHS compliant version.

Compliance with EU REACH

Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

#### **Application**

Miniature switch

Counters and sorter

Position sensor

Infrared applied system

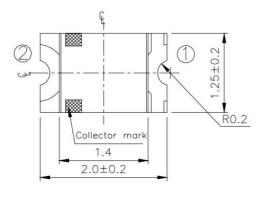
#### **Description**

ST-1T085C is a phototransistor in miniature SMD Package which is molded in a black epoxy with flat top view lens. The device is Spectrally matched to visible and infrared emitting diode.



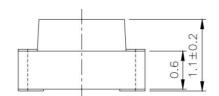


#### **PACKAGE DIMENSIONS**

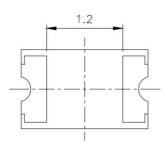


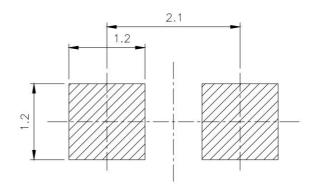
- (1) Emitter
- 2 Collector





For reflow soldering (Propose)





#### NOTES:

- 1.All dimensions are in millimeters
- 2.Tolerances unless dimensions ±0.1mm
- 3.Suggested pad dimension is just for reference only
  Please modify the pad dimension based on individual need



#### **ABSOLUTE MAXIMUM RATINGS AT TA =25°C**

Parameter	Symbol	Rating	Units
Collector-Emitter Voltage	$V_{CEO}$	30	V
Emitter-Collector-Voltage	$V_{ECO}$	5	V
Collector Current	I <sub>C</sub>	20	mA
Operating Temperature	$T_{opr}$	-25 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{stg}$	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Soldering Temperature *1	$T_{sol}$	260	$^{\circ}\!\mathbb{C}$
Power Dissipation at(or below) 25℃ Free Air Temperature	Pc	75	mW

**Notes:** \*1:Soldering time≦5 seconds.



### **ELECTRICAL OPTICAL CHARACTERISTICS AT TA=25°C**

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Rang Of Spectral Bandwidth	λ 0.5		400		1100	nm
Wavelength Of Peak Sensitivity	λp			940		nm
Collector-Emitter Breakdown Voltage	$\mathrm{BV}_{\mathrm{CEO}}$	$I_{\rm C}=100 \mu{\rm A}$ Ee=0mW/cm <sup>2</sup>	30			V
Emitter-Collector Breakdown Voltage	$\mathrm{BV}_{\mathrm{ECO}}$	$I_E=100 \mu A$ $Ee=0 \text{mW/cm}^2$	5			V
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> =2mA Ee=1m W/cm <sup>2</sup>			0.4	V
Collector Dark Current	$ m I_{CEO}$	$\begin{array}{c} V_{CE}=20V \\ Ee=0\text{mW/cm}^2 \end{array}$			100	nA
On State Collector Current	$I_{C(ON)}$	$V_{CE}$ =5 $V$ Ee=1 $mW/cm^2$	0.3	1.0		mA
Rise Time	$t_{\rm r}$	V <sub>CE</sub> =5V		15		μS
Fall Time	$t_{ m f}$	$I_{\rm C}=1$ mA $R_{\rm L}=1000\Omega$		15		



### **Typical Electro-Optical Characteristics Curves**

Fig.1Collector Power Dissipation vs.

**Ambient Temperature** 

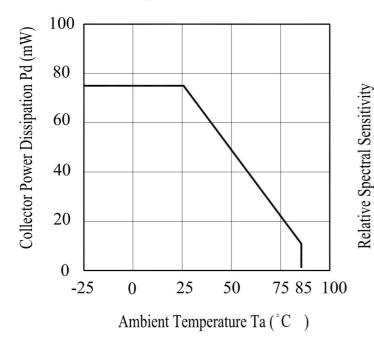


Fig.2 Spectral Sensitivity

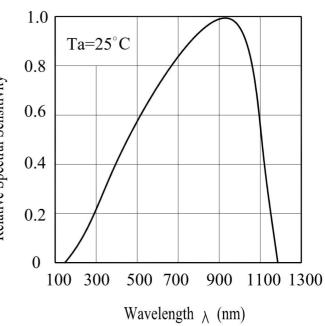


Fig.3 Relative Collector Current vs.

Ambient Temperature

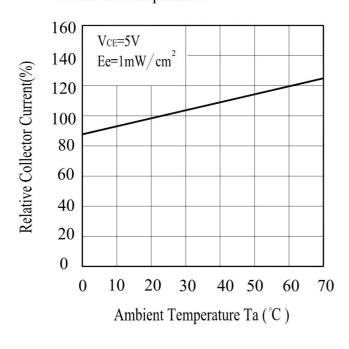
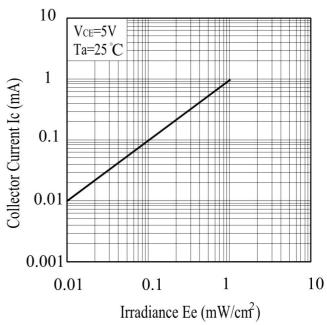


Fig.4 Collector Current vs.
Irradiance





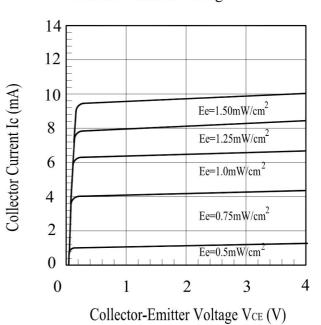
### **Typical Electro-Optical Characteristics Curves**

Fig.5 Collector Dark Current vs.

Ambient Temperature  $10^{-6}$ 5 Vce=20V Collector Dark Current ICEO (A) 2 10<sup>-7</sup> 10-8 5 10-9 10 25 50 75 100 0 Ambient Temperature Ta (°C)

Fig.6 Collector Current vs.

Collector-Emitter Voltage





#### **Precautions For Use**

#### 1. Over-current-proof

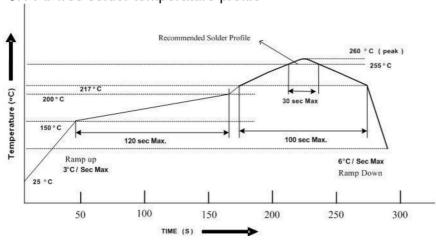
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 10°C~30°C and 90%RH or less.
- 2.3 The LEDs suggested be used within one year.
- 2.4 After opening the package, the devices must be stored at 10°C~30°C and ≤ 60%RH, and used within 168 hours (floor life). If unused LEDs remain, it should be stored in moisture proof packages.
- 2.5 If the moisture absorbent material (desiccant material) has faded or unopened bag has exceeded the shelf life or devices (out of bag) have exceeded the floor life, baking treatment is required.
- 2.6 If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the following conditions:
  - 96 hours at 60°C ± 5°C and < 5 % RH (reeled/tubed/loose units)

#### 3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

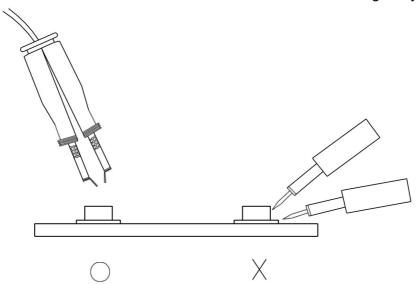


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

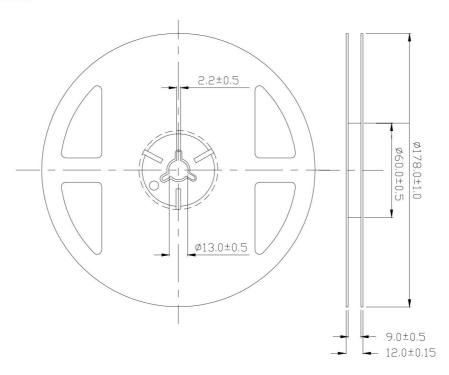
#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

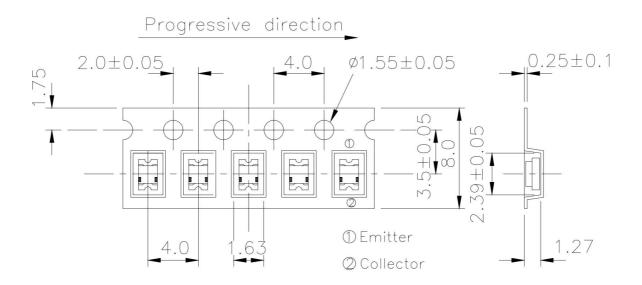




### **Package Dimensions**



### **Taping Dimensions**



#### SMD Phototransistor

## ST-1T085C



### **Packing Quantity Specification**

- 1. 3000Pcs/1Reel,10 Reel/1Box
- 3. 4Boxes/1Carton

### **Label Form Specification**



· PRODUCT: Part Number

· CODE NO.: Product Serial Number

QTY: Packing Quantity LOT No: Lot Number

· REMARKS:Remarks



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